High VoltageLED Series Chip on Board

COB R - Series Vegetable

High efficacy COB LED package well-suited for use in spotlight applications



Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination



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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Model	Rating	Unit	Condition
Ambient / Operating Temperature	Ta		-40 ~ +105	°C	-
Storage Temperature	T _{stg}		-40 ~ +120	°C	-
LED Junction Temperature	TJ		130	°C	-
Case Temperature	Тс		115	°C	-
		LC013D	920 / 34.5		-
		LC016D	1150 / 43.1		-
Forward Current / Power Dissipation	IF / PD	LC019D	1380 / 51.8	mA / W	-
		LC026D	1840 / 69		-
		LC033D	2300 / 86		-
ESD (HBM)	-		±2	kV	-

b) Electro-optical Characteristics (I_F = Sorting Current, T_J = 65 °C)

ltem	Unit	Model	Rank	Min.	Тур.	Max.
Forward Voltage (V _F)	V		YZ	31.8	34.6	37.5
		LC013D	-	-	1.53	-
		LC016D	-	-	1.21	-
Thermal Resistance (junction to chip case)	°C/W	LC019D	-	-	1.08	-
		LC026D	-	-	0.85	-
		LC033D	-	-	0.72	-
Beam Angle	0		-	-	115	-
		LC013D	-	-	12.5 (360)	-
		LC016D	-	-	15.6 (450)	-
Nominal Power (Sorting Current)	W (mA)	LC019D	-	-	18.7 (540)	-
		LC026D	-	-	24.9 (720)	-
		LC033D	-	-	31.1 (900)	-

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature (T_J = T_C = T_a = 65 °C)
- 2) Samsungmaintains measurement tolerance of: forward voltage = ± 5 %, CRI = ± 1
- 3) Refer to the derating curve, '3. Typical Characteristics Graph'designed within the range.

c) Luminous FluxCharacteristics (I_F = Sorting Current)

Madal	Nominal	Flux		T _c = 65 °C (lm)	
Model	CCT (K)	Rank	Min.	Тур.	Max.
LC013D	Vegetable	D2	1128	1188	-
LC016D	Vegetable	D2	1467	1544	-
LC019D	Vegetable	D2	1744	1835	-
LC026D	Vegetable	D2	2279	2399	-
LC033D	Vegetable	D2	2820	2969	-

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature $(T_j = T_c = 65 \text{ °C}).$
- 2) Samsungmaintains measurement tolerance of: Luminous flux = \pm 7 %, CRI = \pm 1

2. Product Code Information

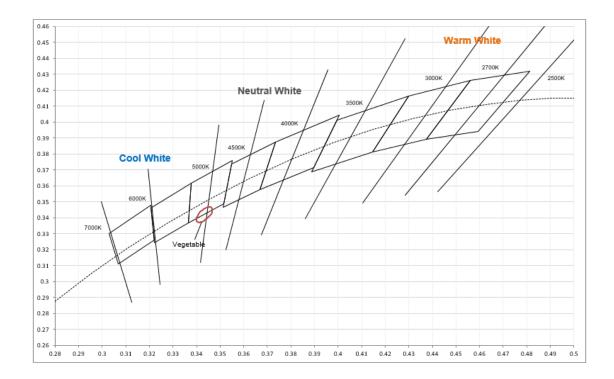
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S																	

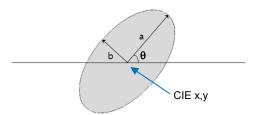
Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WН	White color
6	Product Version	А	
7 8	Form Factor	HD	СОВ
9	Lens Type	N	No lens
		D	LC013
		E	LC016
10	Internal Code	F	LC019
		G	LC026
		н	LC033
11	Internal Code	2	
12	CRI & Sorting Temperature	v	VIVID 65 °C
13 14	Forward Voltage (V)	YZ	31.8~37.5
15	CCT (K)	R	Vegetable
16	MacAdam	s	Color Bin for Samsung Special Color
17 18	Luminous Flux	D2	COB D-series Gen.2 level

a) Binning Structure (I_F= Sorting Current, T_J =65 °C)

Model	Nominal	Product Code	V _F	Color	Flux	Flux Range
Moder	CCT (K)		Rank	Rank	Rank	(Φ _v , Im)
LC013D	Vegetable	SPHWHAHDND2VYZRSD2	YZ	RS	D2	1128~
LC016D	Vegetable	SPHWHAHDNE2VYZRSD2	YZ	RS	D2	1467~
LC019D	Vegetable	SPHWHAHDNF2VYZRSD2	YZ	RS	D2	1744~
LC026D	Vegetable	SPHWHAHDNG2VYZRSD2	YZ	RS	D2	2279~
LC033D	Vegetable	SPHWHAHDNH2VYZRSD2	YZ	RS	D2	2820~

b) Chromaticity Region & Coordinates $(I_F = Sorting Current, T_J = 65 \ ^{\circ}C)$

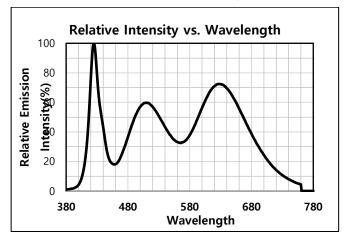




		MacAdam Ellipse			
Step	CIE x	CIE y			b
2-step	0.3433	0.3421	59.62	0.0055	0.0024

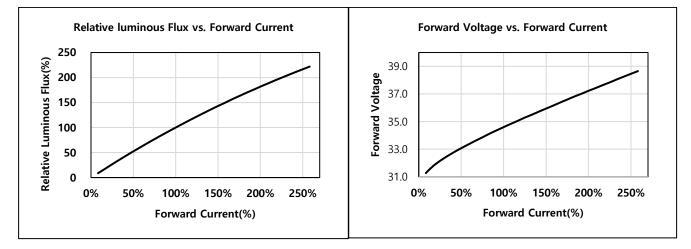
3. Typical Characteristics Graphs

a) Spectrum Distribution (I_F = Sorting Current, T_J = 65 °C)



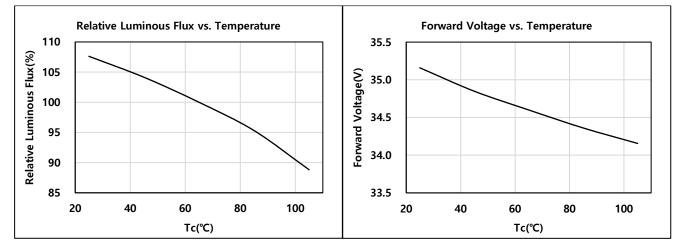
b) Forward Current Characteristics (T_J = 65 °C)

Vegetable



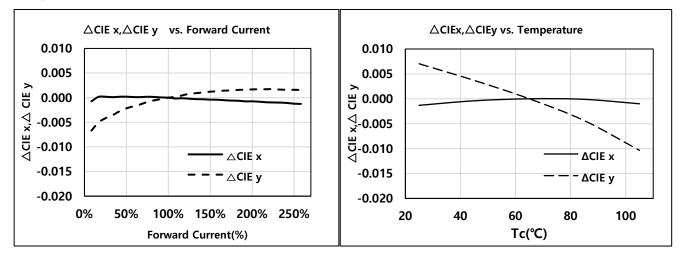
b) Temperature Characteristics(IF = Sorting Current)

Vegetable

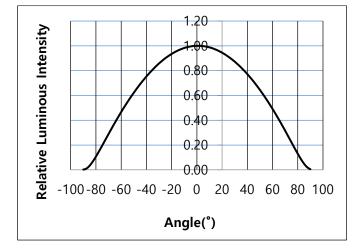


c) Color Shift Characteristics (I_F =Sorting Current, T_J = 65 °C)

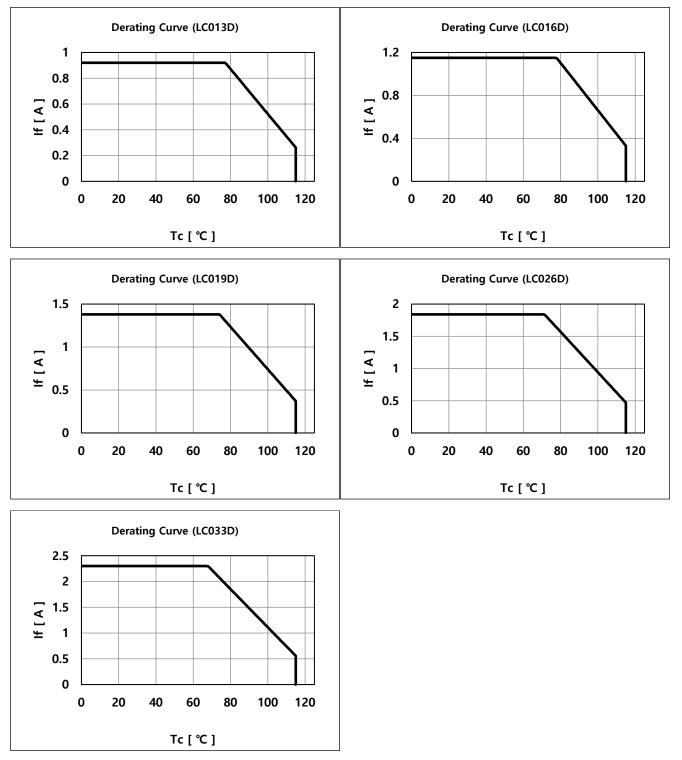
Vegetable



d) Beam Angle Characteristics (I_F = Sorting Current, T_J = 65 °C)

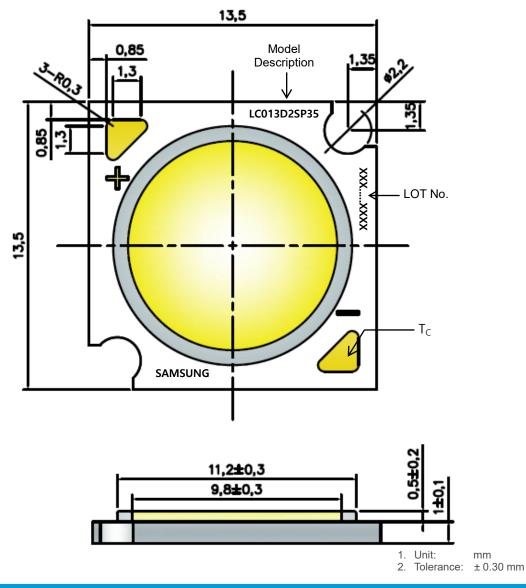


f) Derating Characteristics



4. Outline Drawing & Dimension

1) LC013D

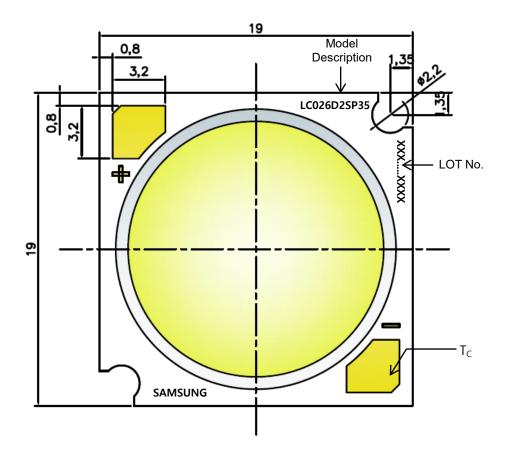


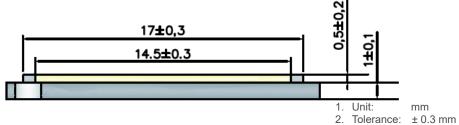
	Item	Dimension	Tolerance	Unit
Length		13.5	±0.15	mm
Width		13.5	±0.15	mm
	Dam	0.5	±0.20	mm
Height	Substrate	1.0	±0.10	mm
LES Diameter	Light Emitting Surface	9.8	±0.30	mm

Note: Denoted product information above is only an example

(LC013D2SP35 :13W, Special Color, Fashion)

2) LC016D, LC019D, LC026D, LC033D





			2. Tolefance.	10.01111
	ltem	Dimension	Tolerance	Unit
Length		19.0	±0.15	mm
Width		19.0	±0.15	mm
	Dam	0.5	±0.20	mm
0	Substrate	1.0	±0.10	mm
LES Diameter	Light Emitting Surface	14.5	±0.30	mm

Note: Denoted product information above is only an example (LC026D2SP35 : 26W, Special Color, Fashion)

5. Reliability Test Items & Conditions

a) Test Items

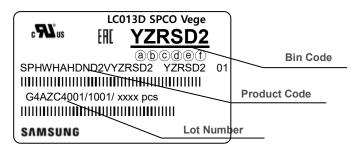
Test Item	Test Condition	Test Hour / Cycle
High Temperature Life Test	85 °C, DC Derating, I _F	1000 h
Low Temperature Life Test	-40 °C, DC, Derating I⊧	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
TemperatureCycle On/Off Test	-40 °C/ 85 °C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, I _F = max	100 cycles
ESD (HBM)	R1: 10 MΩ R2: 1.5 kΩ C: 100 pF V: ±2 kV	5 times
Vibration Test	20~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times
Sulfur Resistance	25 °C, 75%, H2S 15 ppm	504h

b) Criteria for Judging the Damage

ltem	Symbol	Test Condition	Limit		
Item	Зуший	(T _c = 25 °C)	Min.	Max.	
Forward Voltage	VF	I _F = Sorting Current	L.S.L. * 0.9	U.S.L. * 1.1	
Luminous Flux	Φ_{v}	I⊧ =Sorting Current	L.S.L * 0.7	U.S.L * 1.3	

6. Label Structure

a) Label Structure



Note: Denoted bincode and product code above is only an example (see description on page 5)

Bin Code:

- (a) (b): Forward Voltagebin (refer to page 3)
- ©d: Chromaticitybin (refer to page 6)
- (e) f): Luminous Fluxbin (refer to page 4)

b) Lot Number

The lot number is composed of the following characters:



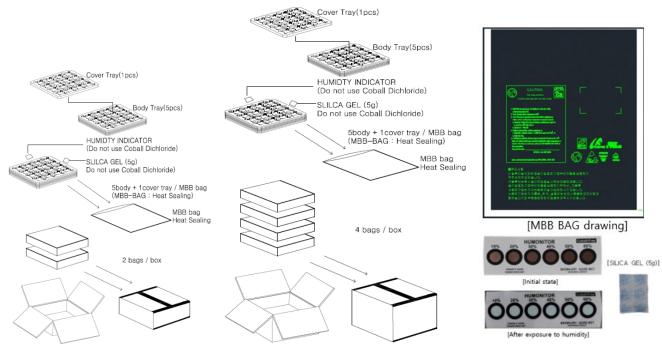
- ① 3456789 / 1abc / xxxx pcs
- 1 : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : 4(LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- (4) : Year (Z: 2015, A: 2016, B: 2017...)
- (5) : Month (1~9, A, B, C)
- 6789 : Day (1~9, A, B~V)
- (a)(b)(c) : Product serial number (001 ~ 999)

7. Packing Structure

1) LC013D

	Max. quantity	Dimension(mm)				
Packing material	in pcs of COB	Length	Width	Height	Tolerance	
Tray	50	200	200	8	1	
Anti-Static Bag	250 (5 trays)	320	270	-	+/- 0.5	
Outer Box (Small)	500 (2 bags)	225	225	65	5	
Outer Box (Middle)	1000 (4 bags)	225	225	130	5	

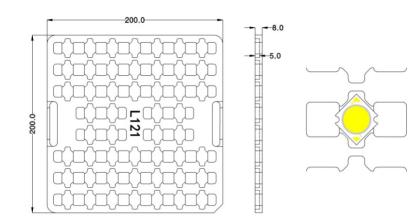
a) Packing Structure



% Small Box



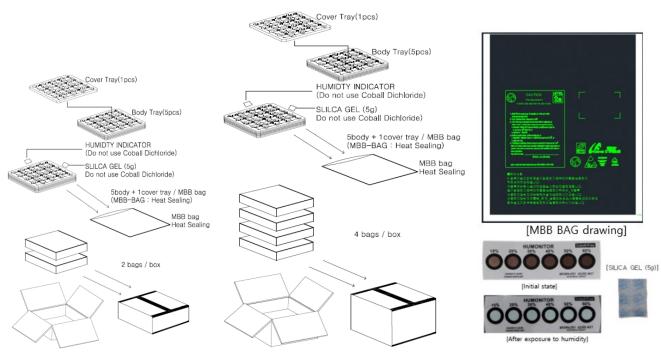
b) Tray



2) LC016D, LC019D, LC026D, LC033D

	Max. quantity	Dimension(mm)				
Packing material	in pcs of COB	Length	Width	Height	Tolerance	
Тгау	25	200	200	8	1	
Anti-Static Bag	125 (5 trays)	320	270	-	+/- 0.5	
Outer Box (Small)	250 (2 bags)	225	225	65	5	
Outer Box (Middle)	500 (4 bags)	225	225	130	5	

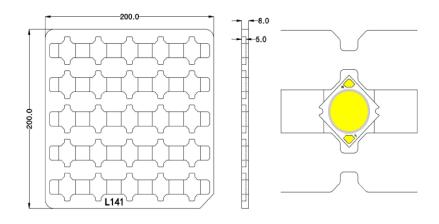
a) Packing Structure



% Small Box



b) Tray

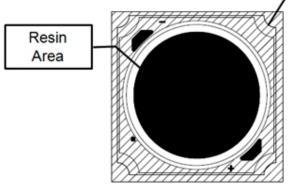


8. Precautions in Handling & Use

- 1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 2) LEDs must be stored in a clean environment. Shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH.
- After storage bag is opened, device subjected to soldering (wiring), or other high temperature processes must be:
 a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
 For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the minimum current level (If_min), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

11) The resin area is very sensitive, please do not handle, press, touch, <u>rub</u>, <u>clean</u>, <u>or pick</u> by with tweezers on it. Instead, please pick at the handling area as indicated below.

Area



Legal and additional information.

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